

2826

Docket No. 740756-2138

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of)
Takayuki IKEDA et al.) Examiner: Ahmed N. SEFER
Serial No. 09/542,473)
Filed: April 4, 2000) Group Art Unit: 2826
For: ELECTROOPTICAL DEVICE AND A METHOD) Confirmation No. 6069
OF MANUFACTURING THE SAME)

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, on January 29, 2004.


Name: Jacob A. Poushter

FOURTH REQUEST FOR ACKNOWLEDGMENT OF
INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
Washington, D.C. 20231

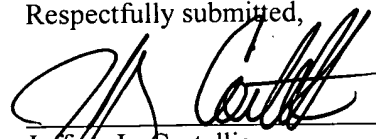
Sir:

An Information Disclosure Statement with Form PTO-1449 was filed in the above-identified patent application on September 4, 2001. Applicants have received back from the Examiner a copy of the Form PTO-1449 partially initialed to acknowledge the fact that the Examiner has considered the cited disclosed information.

The Examiner is requested to initial and return to the undersigned a copy of the subject Form PTO-1449.

Should there be any questions concerning this communication, please telephone the undersigned at the number set forth below.

Respectfully submitted,


Jeffrey L. Costellia
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Form PTO-1449
(Rev. 8-83)Department of Commerce
Patent and Trademark Office

Atty Docket 0756-2558

Serial No. 09/542,473

INFORMATION DISCLOSURE STATEMENT

Applicants: Takayuki IKEDA

Filing Date: April 04, 2000

Group Art Unit: 2826

U.S. PATENT DOCUMENTS

Examiner Initial	Document Number	Date	Name	Class	Subclass	Filing Date (if appropriate)
	6,013,929	01/11/2000	Ohtani			

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

Examiner Initial	
	Specifications and Drawings for Application Serial No. 08/862,895, "Semiconductor Intergrated Circuit and Fabrication Method Thereof", Filing Date: May 23, 1997, Inventor: Hisashi OHTANI
	Specifications and Drawings for Application Serial No. 09/468,859, "Thin Film Transistor, Method of Manufacturing the Same, and Semiconductor Device Including the Same" Filing Date: December 21, 1999, Inventor: Hisashi OHTANI
	Specifications and Drawings for Application Serial No. 09/487,432, "Semiconductor Device and Process for Production Thereof" Filing Date: January 19, 2000, Inventors: Shunpei YAMAZAKI et al.
	Specifications and Drawings for Application Serial No. 09/493,411, "Semiconductor Device and Method of Fabricating the Same" Filing Date: January 28, 2000, Inventors: Shunpei YAMAZAKI et al.

Examiner

Date Considered

*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

00/04/2000

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